### STL36DN6F7



# Dual N-channel 60 V, 23 mΩ typ., 33 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 5x6 double island package

Datasheet - production data

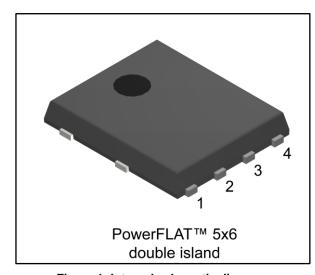
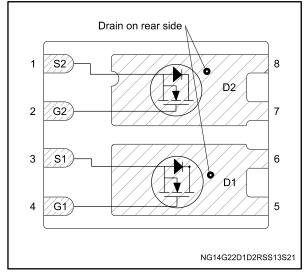


Figure 1: Internal schematic diagram



#### **Features**

Order code	V <sub>DS</sub> R <sub>DS(on)</sub> max		ΙD
STL36DN6F7	60 V	27 mΩ	33 A

- Among the lowest R<sub>DS(on)</sub> on the market
- Excellent figure of merit (FoM)
- Low C<sub>rss</sub>/C<sub>iss</sub> ratio for EMI immunity
- High avalanche ruggedness

### **Applications**

• Switching applications

#### **Description**

This dual N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

**Table 1: Device summary** 

Order code	Marking	Package	Packing
STL36DN6F7	36DN6F7	PowerFLAT™ 5x6 double island	Tape and reel

Contents STL36DN6F7

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STL36DN6F7 Electrical ratings

# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	60	V
$V_{GS}$	Gate-source voltage	±20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	33	Α
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	23	Α
I <sub>D</sub> <sup>(2)</sup>	Drain current (continuous) at T <sub>pcb</sub> = 25 °C	9	Α
I <sub>D</sub> <sup>(2)</sup>	Drain current (continuous) at T <sub>pcb</sub> =100°C	6.7	Α
I <sub>DM</sub> <sup>(1)(3)</sup>	Drain current (pulsed)	132	Α
I <sub>DM</sub> <sup>(2)(3)</sup>	Drain current (pulsed)	36	Α
P <sub>TOT</sub> <sup>(1)</sup>	Total dissipation at T <sub>C</sub> = 25 °C	58	W
P <sub>TOT</sub> <sup>(2)</sup>	Total dissipation at T <sub>pcb</sub> = 25°C	4.8	W
TJ	Operating junction temperature range	FF to 47F	00
T <sub>stg</sub>	Storage temperature range	-55 to 175	°C

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction- case	2.6	°C/W
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb	31.3	°C/W

#### Notes:

 $<sup>^{(1)}</sup>$ This value is rated according to R<sub>thj-c</sub>.

 $<sup>\</sup>ensuremath{^{(2)}} The value is rated according to <math display="inline">R_{thj\text{-pcb}}.$ 

 $<sup>\</sup>ensuremath{^{(3)}}\mbox{Pulse}$  width limited by safe operating area.

 $<sup>^{(1)}</sup>$ When mounted on FR-4 board of 1 inch<sup>2</sup>, 2oz Cu, t < 10 s.

Electrical characteristics STL36DN6F7

### 2 Electrical characteristics

(T<sub>C</sub> = 25 °C unless otherwise specified)

Table 4: On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA	60			>
IDSS	Zero gate voltage drain current	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate-body leakage current	V <sub>DS</sub> = 0 V ,V <sub>GS</sub> = 20 V			100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	V <sub>G</sub> S = 10 V, I <sub>D</sub> = 4.5 A		23	27	mΩ

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance	V 00 V ( 4 MI)	ı	420	-	pF
Coss	Output capacitance	$V_{DS} = 30 \text{ V}, f = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$	ı	215	-	pF
Crss	Reverse transfer capacitance	VGS - 0 V	ı	16	-	pF
$Q_g$	Total gate charge V <sub>DD</sub> = 30 V, I <sub>D</sub> = 9 A		ı	8	-	nC
$Q_{gs}$	Gate-source charge V <sub>GS</sub> = 0 to 10 V		ı	2.3	-	nC
$Q_{gd}$	ate-drain charge (see Figure 14: "Test circuit for gate charge behavior")		1	2.1	-	nC

**Table 6: Switching times** 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 30 \text{ V}, I_D = 4.5 \text{ A},$	1	7.85	ı	ns
tr	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see Figure 13: "Test circuit	•	3.25		ns
t <sub>d(off)</sub>	Turn-off delay time	for resistive load switching	ı	12.1	•	ns
t <sub>f</sub>	Fall time	times" and Figure 18: "Switching time waveform")	1	3.95	•	ns

Table 7: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage I <sub>SD</sub> = 9 A, V <sub>GS</sub> = 0 V		ı		1.2	V
t <sub>rr</sub>	Reverse recovery time	$I_D = 9 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$	-	17.1		ns
Qrr	Reverse recovery charge V <sub>DD</sub> = 48 V		ı	6.67		nC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 15: "Test circuit for inductive load switching and diode recovery times")	1	0.8		А

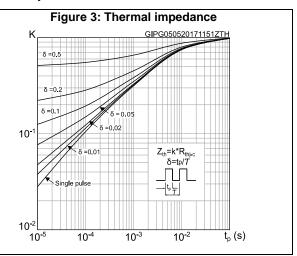
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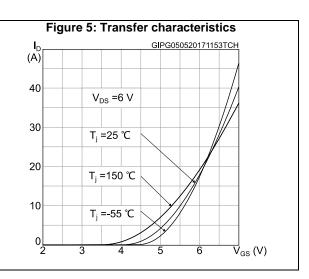


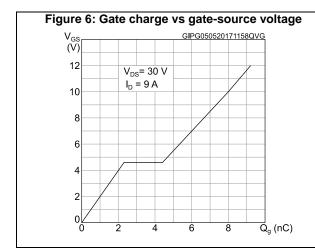
 $<sup>^{(1)}</sup>$ Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%.

### 2.1 Electrical characteristics (curves)

Figure 2: Safe operating area (A) Operation in this area is limited by R<sub>DS(on)</sub> GIPG050520171148SOA 10<sup>2</sup> t<sub>p</sub>=10 μs 10<sup>1</sup> t₀=100 µs T<sub>j</sub>≤175 °C 100  $T_c = 25 \,^{\circ}\text{C}$ t₀=1 ms single pulse t₀=10 ms 10-1 10<sup>0</sup>  $\overline{V}_{DS}(V)$ 







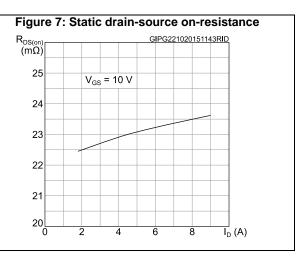
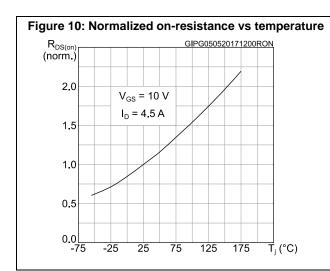
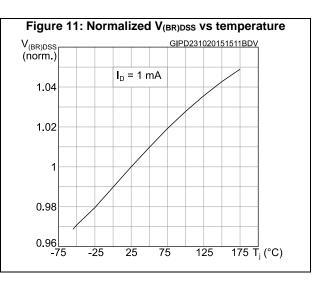
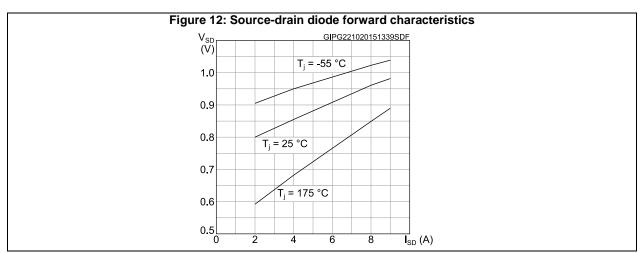


Figure 8: Capacitance variations C (pF) GIPG050520171159CVR C<sub>ISS</sub> Coss 10<sup>2</sup> 10<sup>1</sup>  $C_{\text{RSS}}$ f = 1 MHz 10<sup>0</sup> 50 10 20 30 40 60  $\overline{V}_{DS}(V)$ 







STL36DN6F7 Test circuits

### 3 Test circuits

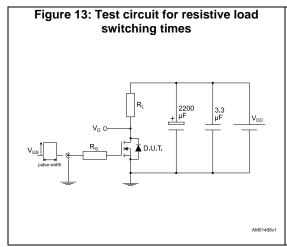


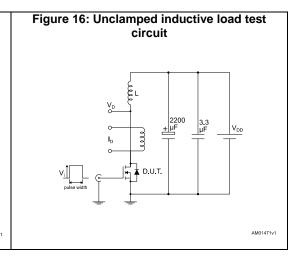
Figure 14: Test circuit for gate charge behavior

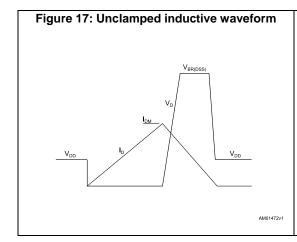
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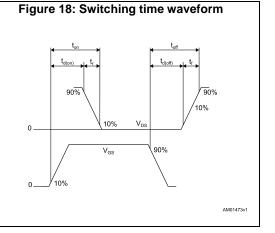
Vos 1 kΩ 1 kΩ

Vos 1 kΩ 1 kΩ

AM01468v1







# 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

# 4.1 PowerFLAT 5x6 double island type C package information

Figure 19: PowerFLAT™ 5x6 double island type C package outline

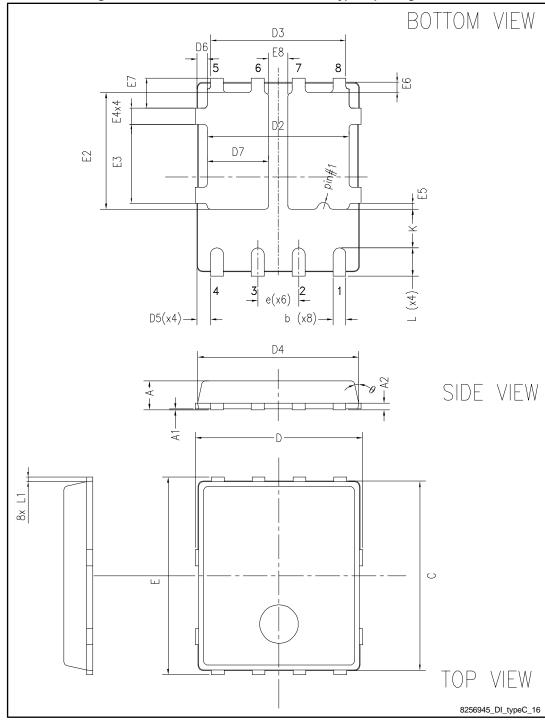
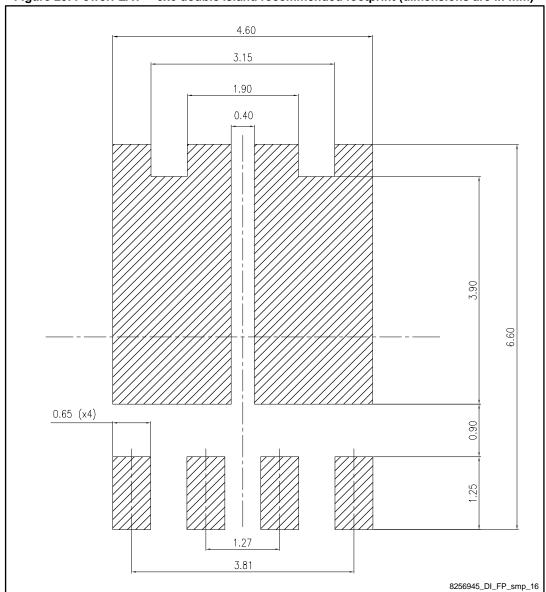


Table 8: PowerFLAT™ 5x6 double island type C mechanical data

	8: PowerFLAT *** 5x6 dour	mm	THE PERSON NAMED IN COLUMN TWO IS NOT THE PERSON NAMED IN COLUMN TWO IS NAM
Dim.	Min.	Тур.	Max.
А	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
С	5.80	6.00	6.20
D	5.00	5.20	5.40
D2	4.15		4.45
D3	4.05	4.20	4.35
D4	4.80	5.00	5.20
D5	0.25	0.40	0.55
D6	0.15	0.30	0.45
D7	1.68		1.98
е		1.27	
E	5.95	6.15	6.35
E2	3.50		3.70
E3	2.35		2.55
E4	0.40		0.60
E5	0.08		0.28
E6	0.20	0.325	0.45
E7	0.75	0.90	1.05
E8	0.55		0.75
K	1.05		1.35
L	0.725		1.025
L1	0.05	0.15	0.25
θ	0°		12°





# 4.2 Packing information

Figure 21: PowerFLAT™ 5x6 tape (dimensions are in mm)

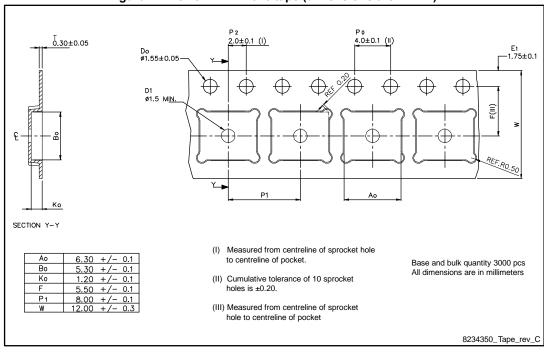
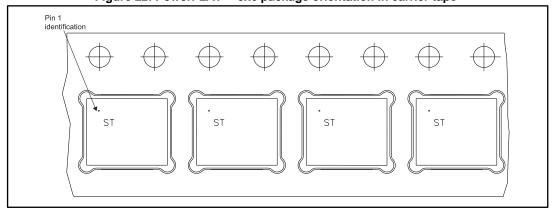


Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape



PART NO.

R25.00

R25.

Revision history STL36DN6F7

# 5 Revision history

Table 9: Document revision history

Date	Revision	Changes	
20-Aug-2015	1	First release.	
22-Oct-2015	2	Document status promoted from preliminary to production data.  Updated Section 2: "Electrical ratings" and Section 3: "Electrical characteristics".  Added Section 3.1: "Electrical characteristics (curves)".	
10-May-2017	3	Modified title and features table on cover page.  Modified Table 2: "Absolute maximum ratings", Table 3: "Thermal data", Table 4: "On /off states"  Modified Figure 4: "Output characteristics", Figure 5: "Transfer characteristics", Figure 7: "Static drain-source on-resistance" and Figure 12: "Source-drain diode forward characteristics".  Minor text changes.	

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